



US00D337118S

United States Patent [19] Seikita

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[54] **EARPHONE**
[75] Inventor: **Mie Seikita, Tokyo, Japan**
[73] Assignee: **Sony Corporation, Tokyo, Japan**
[**] Term: **14 Years**
[21] Appl. No.: **694,060**
[22] Filed: **May 1, 1991**

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Primary Examiner—Bernard Ansher
Assistant Examiner—Sandra Morris
Attorney, Agent, or Firm—Lewis H. Eslinger; Jay H. Maioli

[30] Foreign Application Priority Data

Nov. 1, 1990 [JP] Japan 2-36746
[52] U.S. Cl. **D14/223**
[58] Field of Search **D14/204-206,**
D14/223; D29/19; 181/129; 379/430; 381/25,
68, 68.7, 69.2, 183, 187

[57] CLAIM

The ornamental design for an earphone, as shown.

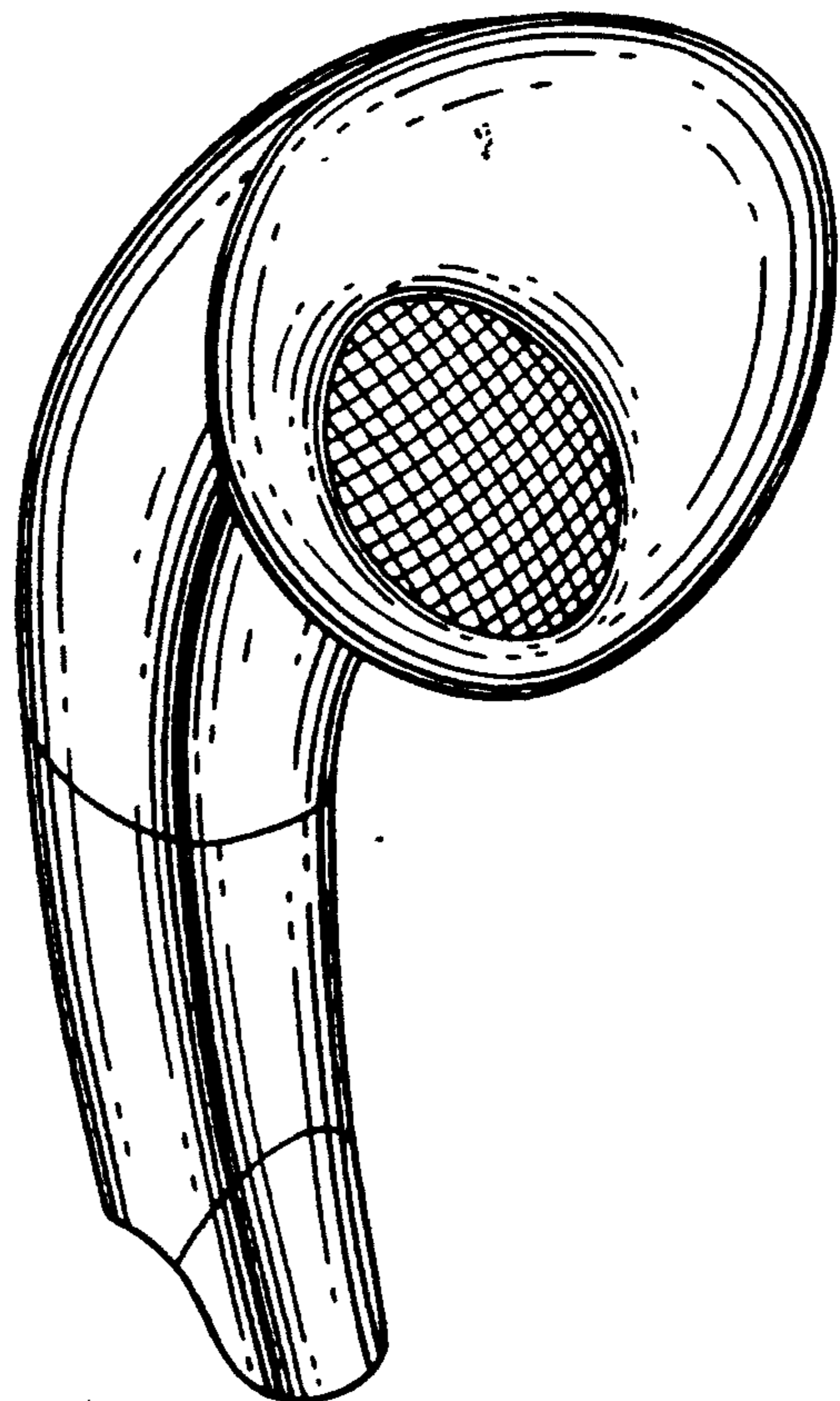
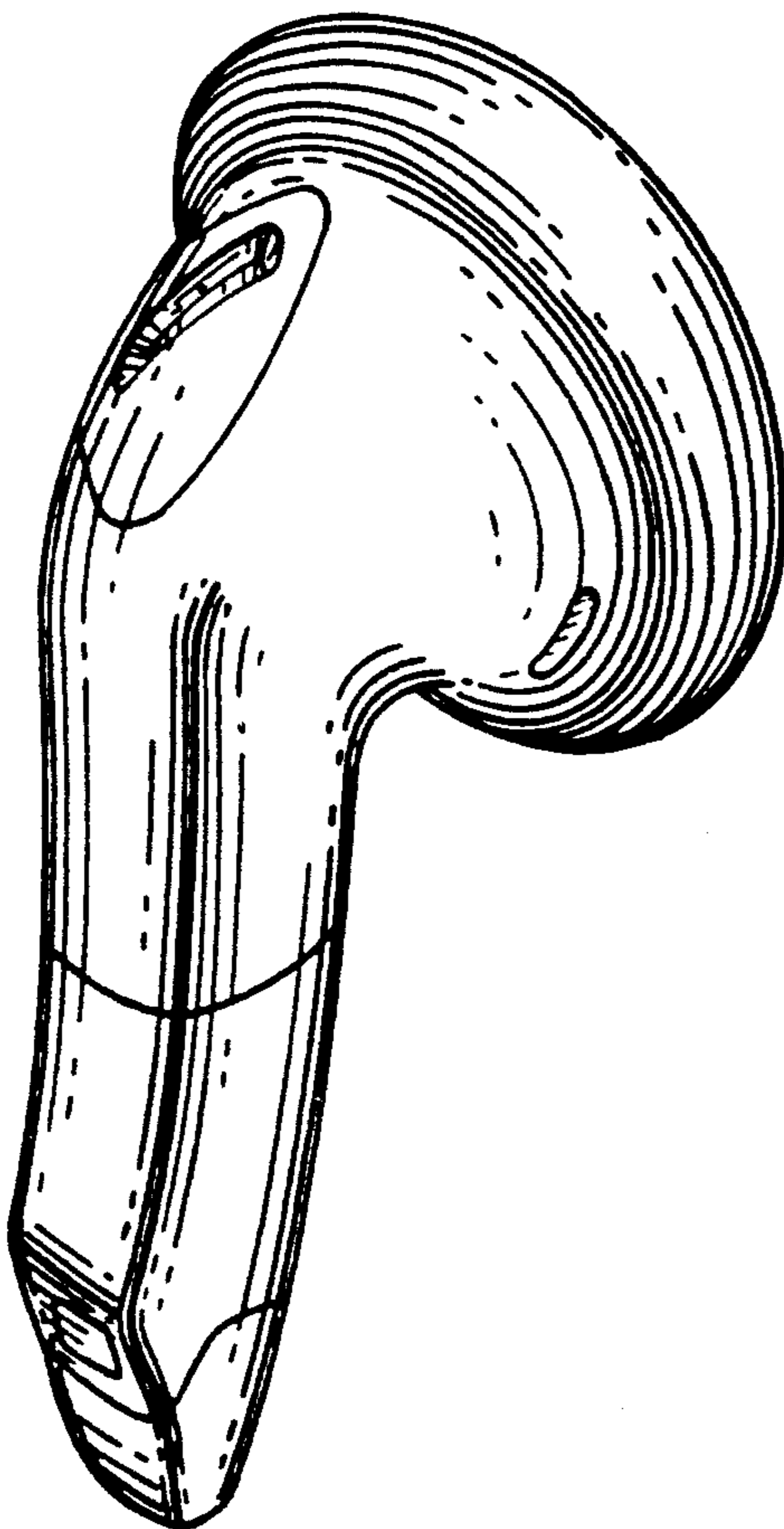
DESCRIPTION

FIG. 1 is a top, rear and left-side perspective view of an earphone showing my new design;
FIG. 2 is a top, front, and left-side perspective view thereof;
FIG. 3 is a front elevational view thereof;
FIG. 4 is a rear elevational view thereof;
FIG. 5 is a left-side elevational view thereof;
FIG. 6 is a right-side elevational view thereof;
FIG. 7 is a top plan view thereof; and,
FIG. 8 is a bottom plan view thereof.

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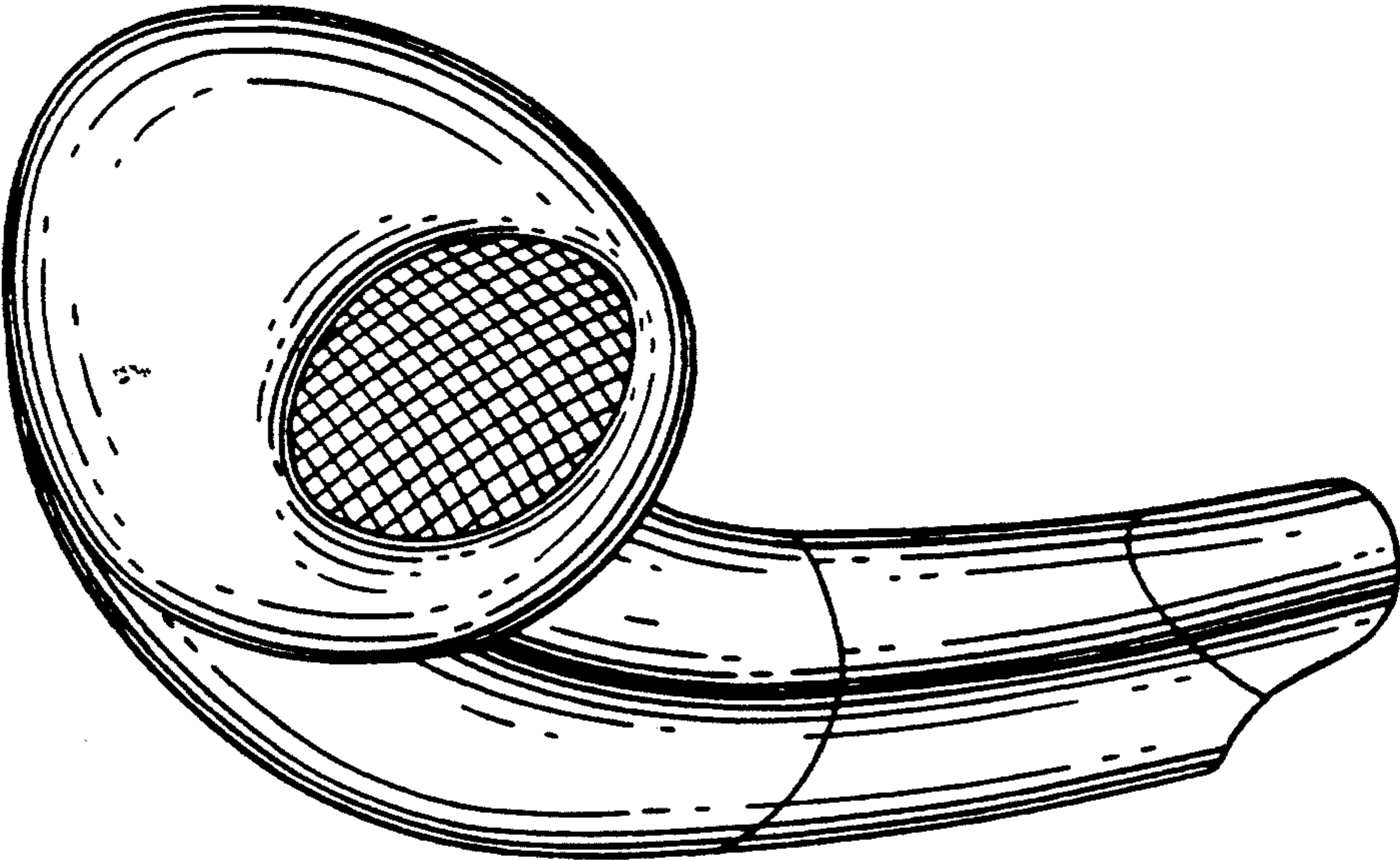


FIG. 2

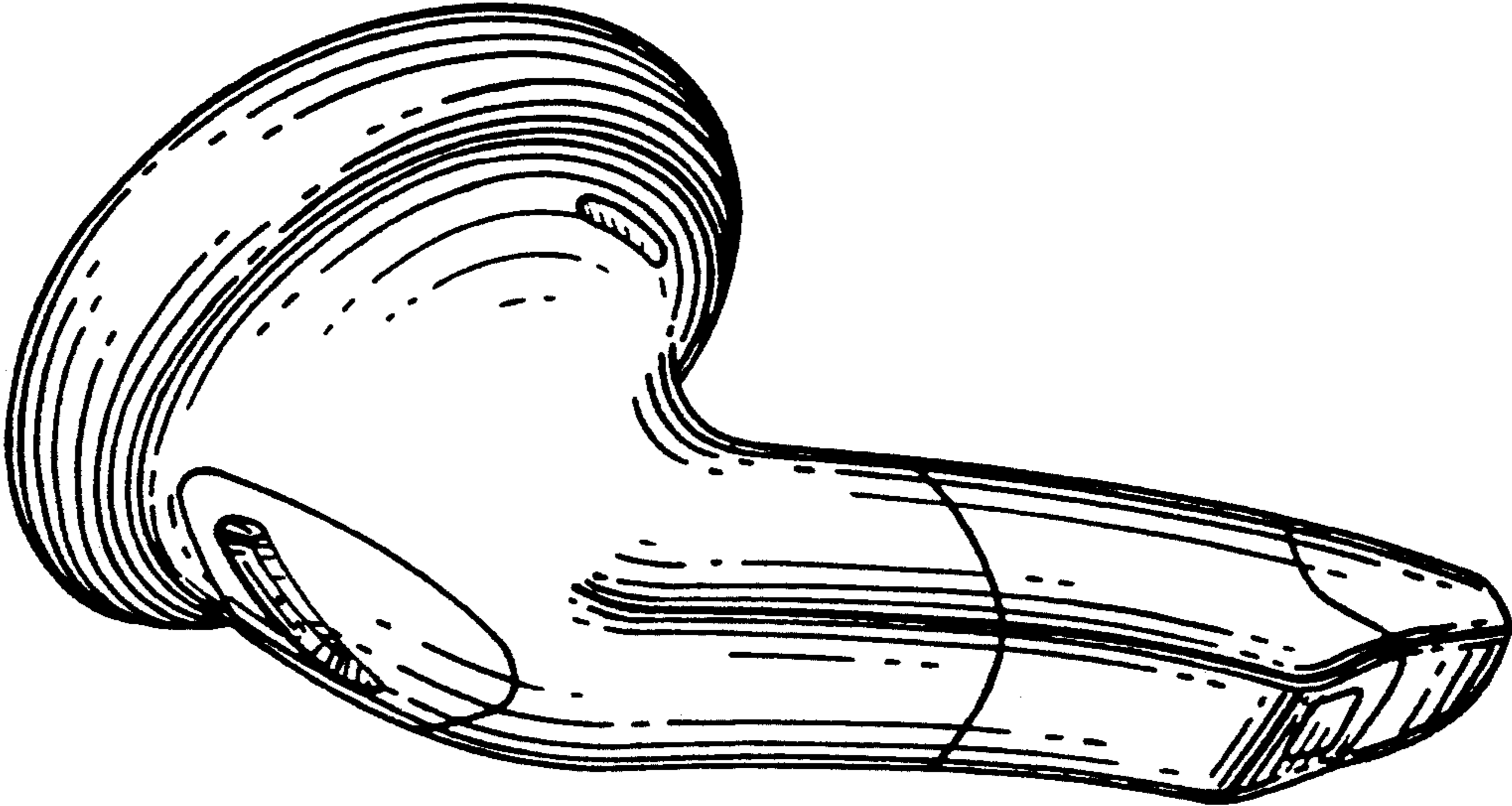


FIG. 1

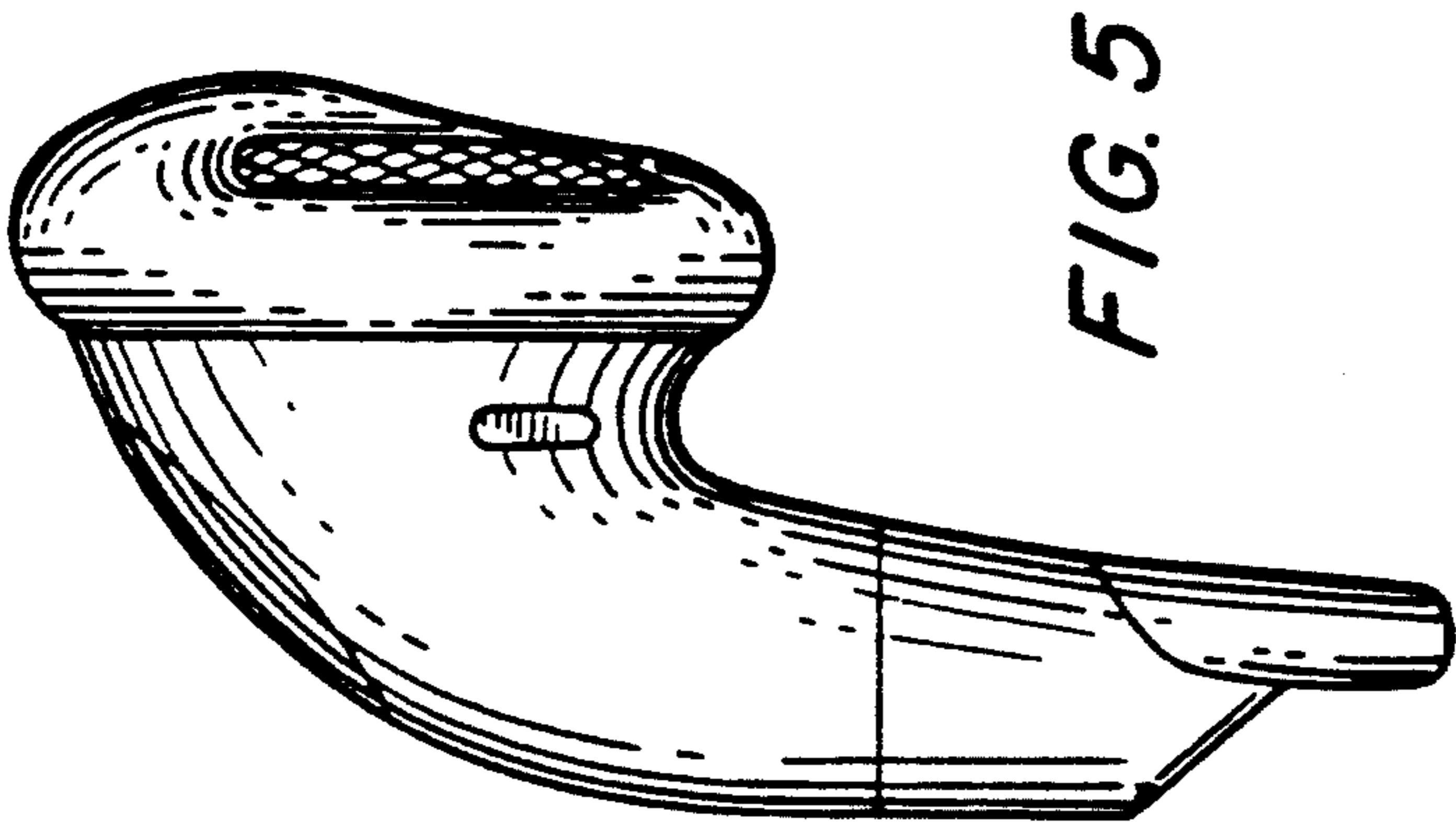


FIG. 5

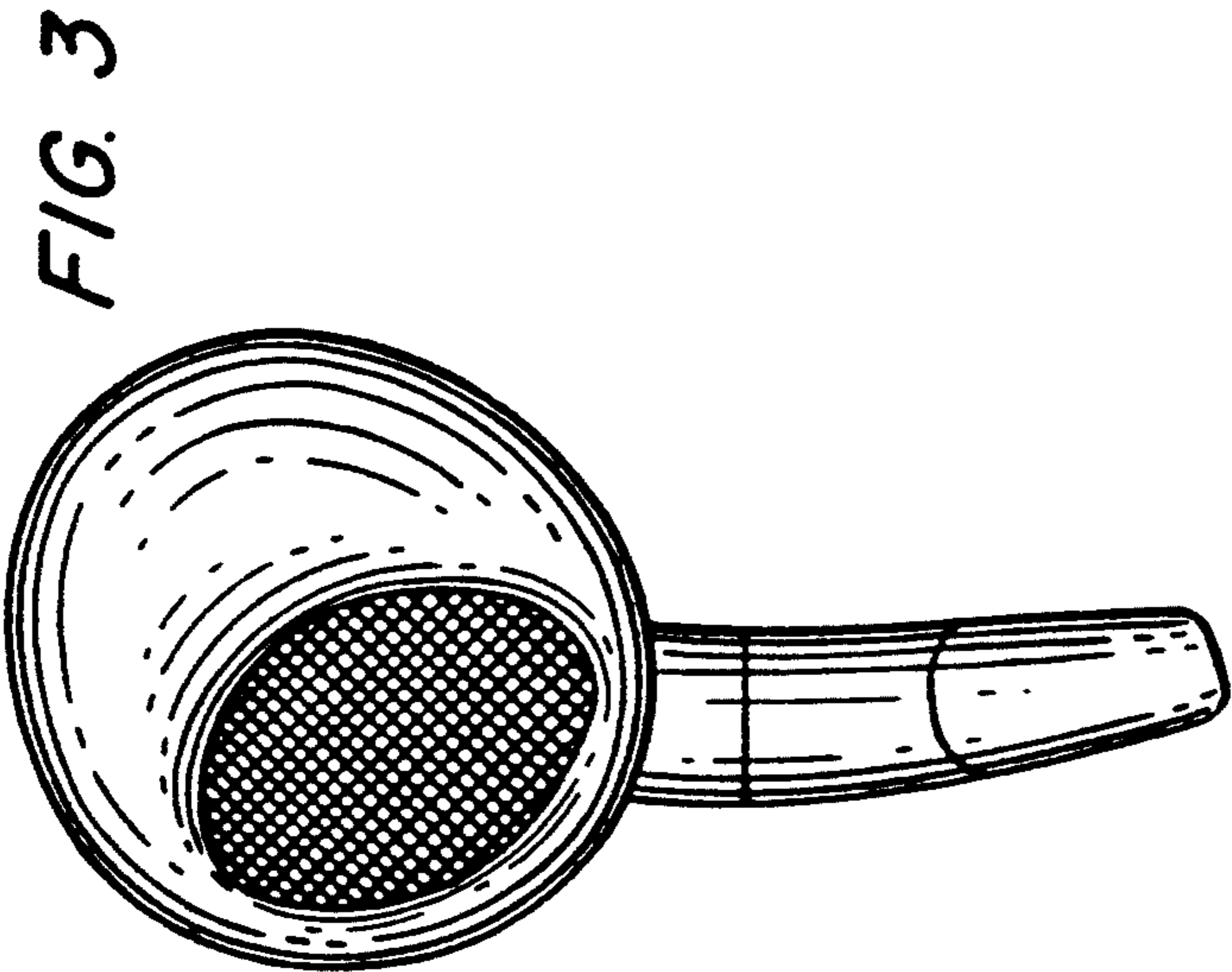


FIG. 3

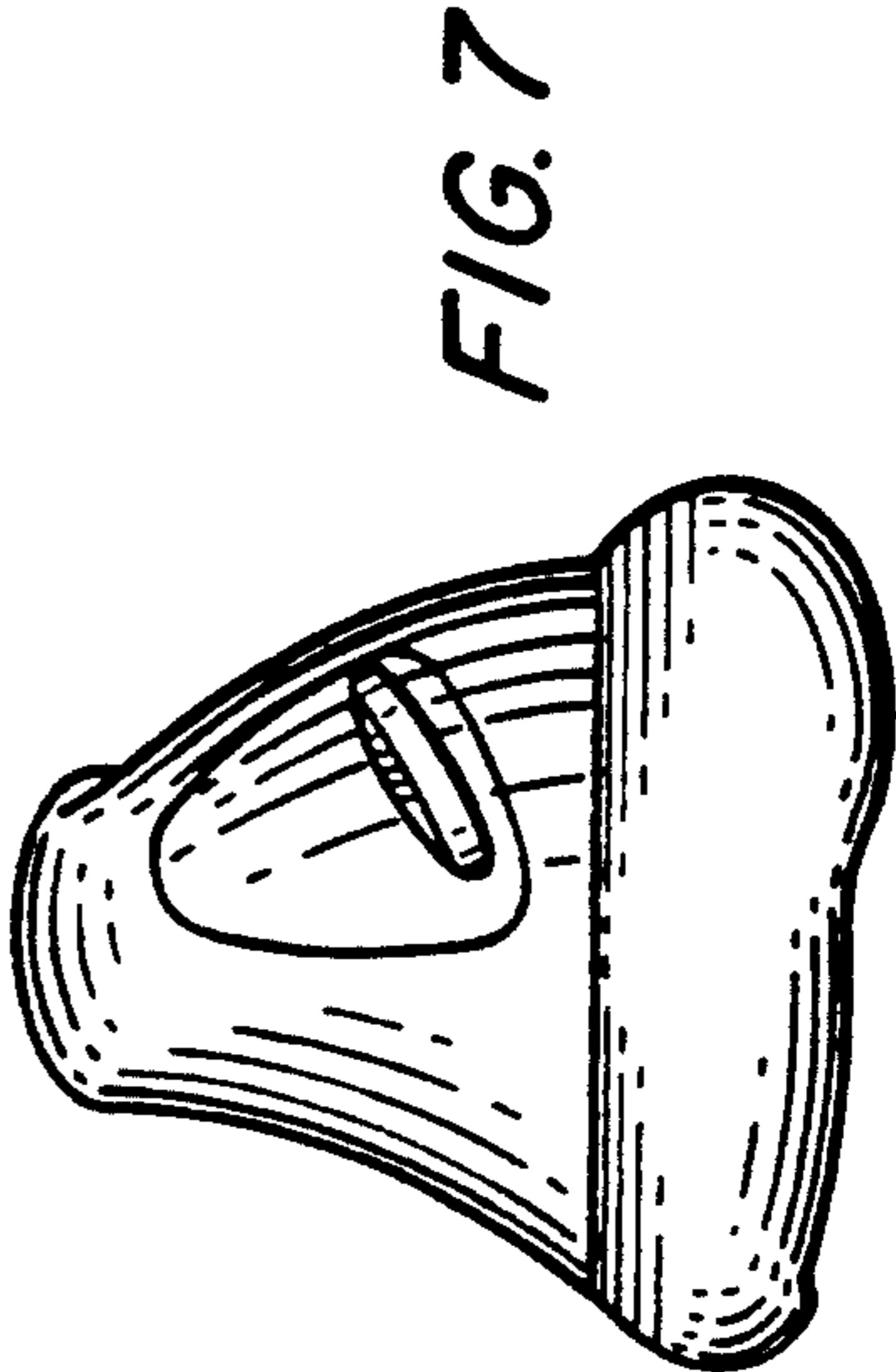


FIG. 7

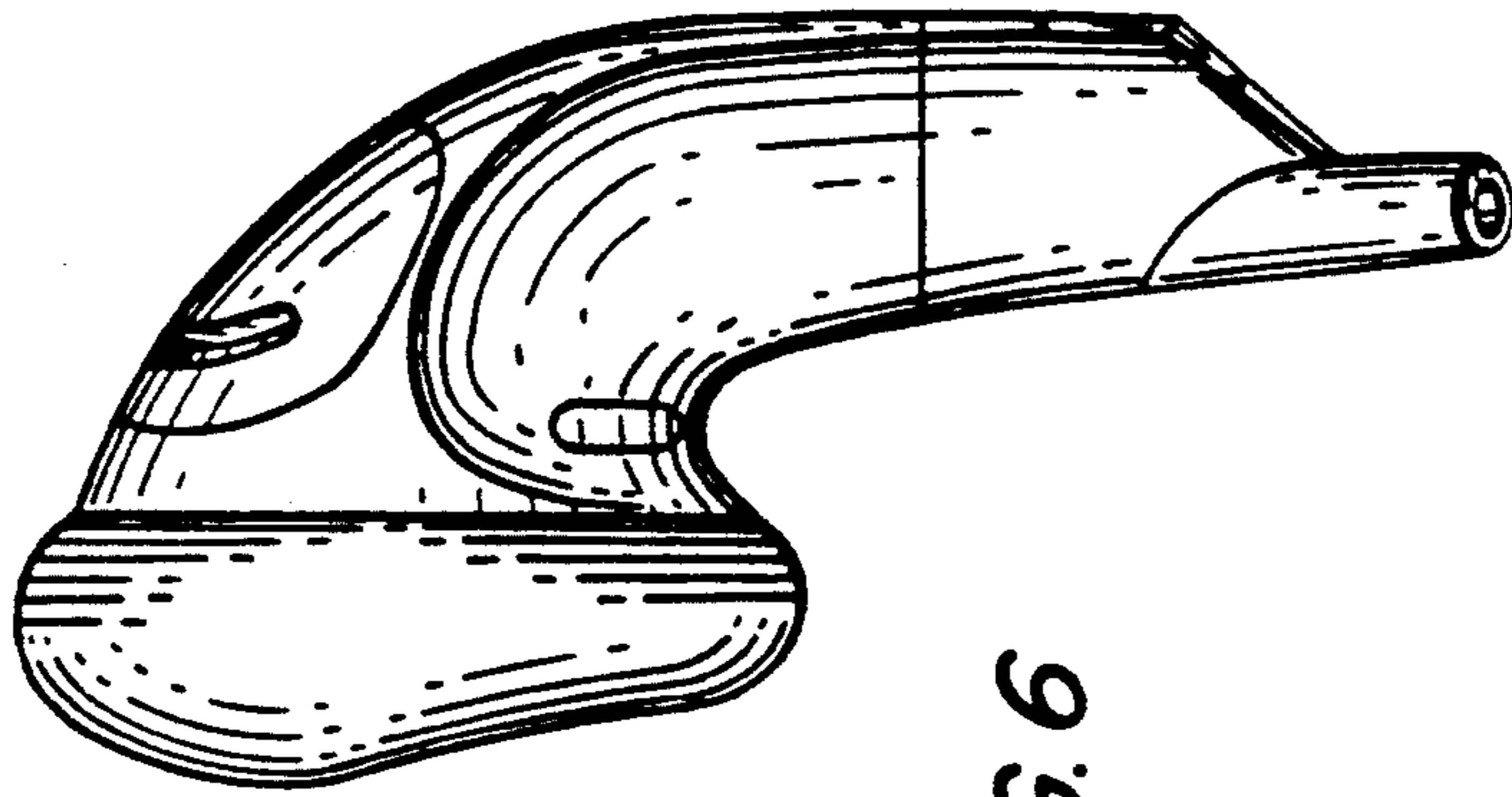


FIG. 6

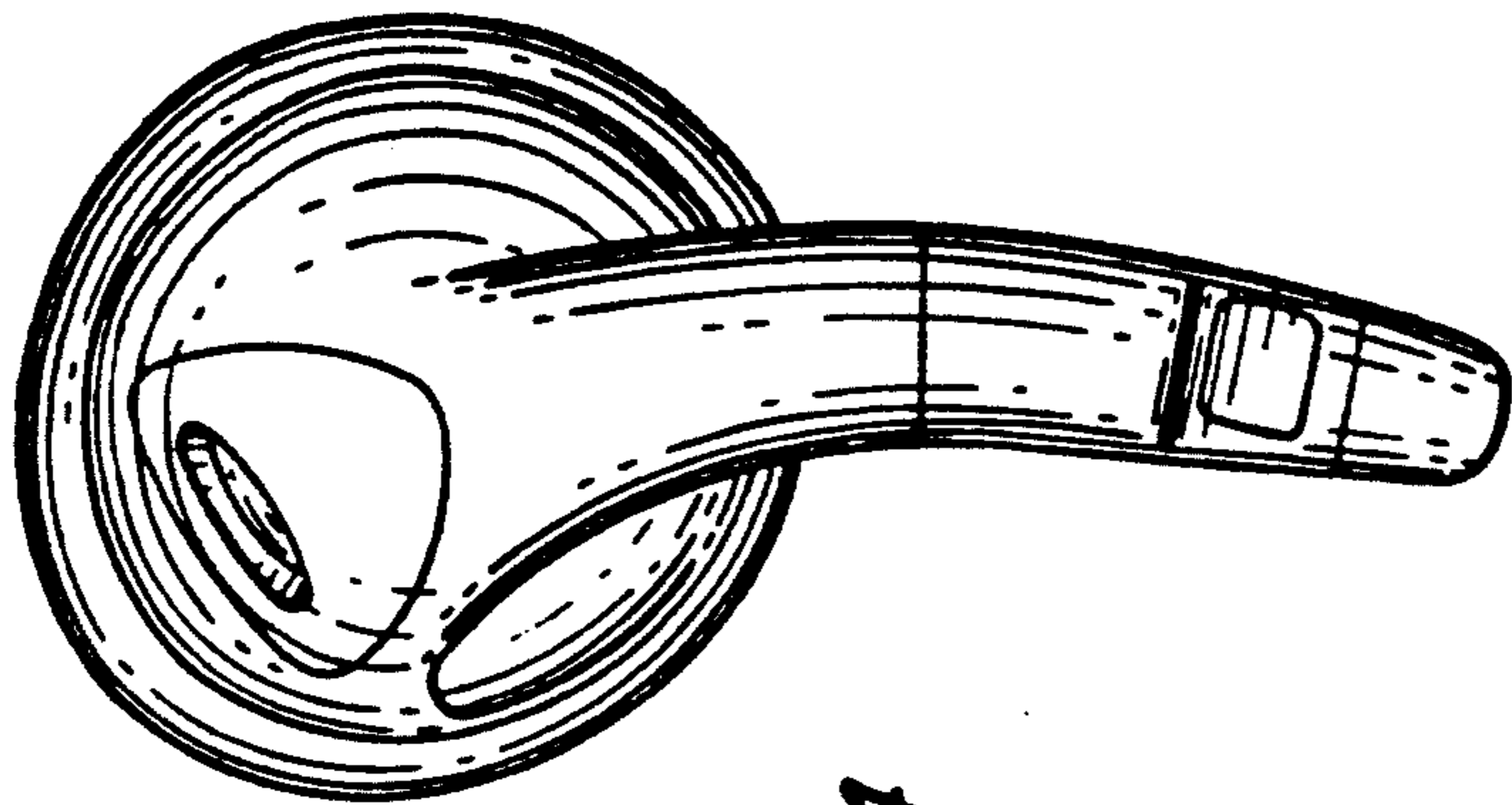


FIG. 4

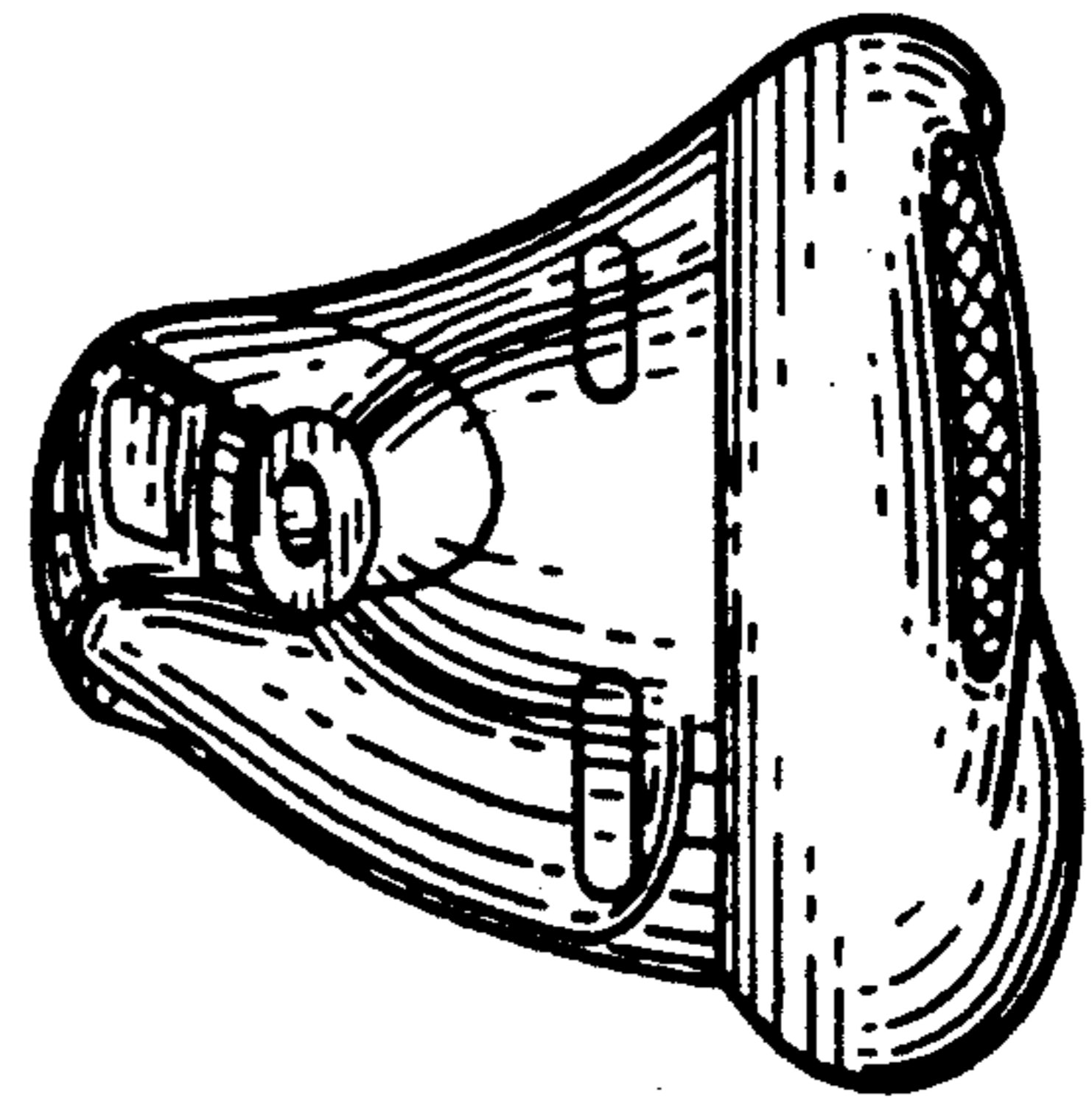


FIG. 8